

## CCD Vertical ClockDriver

### Description

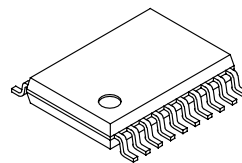
The CXD1267AN is a vertical clock driver for CCD image sensors. This IC is the successor of the CXD1250N with attractive features.

Power consumption is reduced approximately 30% for the CXD1267AN version.

### Features

- 1) Substrate voltage ( $V_{sub}$ ) generator is built-in.
  - Variable  $V_{sub}$  in the range of 4.0V to 18.5V.
  - Reduction of peripheral parts saves space.
- 2) Only two power supplies (+15V and -8.5V) are needed.
- 3) 3.3V clock interface is acceptable.
- 4) 20-pin SSOP package is used.
- 5) Low power consumption
  - 90mW (CXD1267N)
  - 62mW (CXD1267AN)
  - approximately 30% reduction

20 pin SSOP (Plastic)



### Applications

CCD cameras

### Structure

CMOS

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

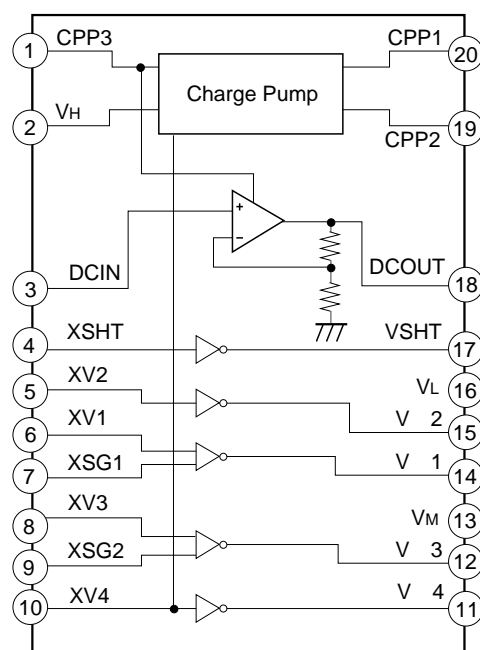
|  |             |                            |    |
|--|-------------|----------------------------|----|
| • Supply voltage                       | $V_L$       | 0 to -10                   | V  |
| • Supply voltage                       | $V_H$       | $V_L - 0.3$ to $2V_L + 35$ | V  |
| • Supply voltage                       | $V_M$       | $V_L - 0.3$ to 3.0         | V  |
| • Input voltage                        | $V_I$       | $V_L - 0.3$ to $V_H + 0.3$ | V  |
| • Output voltage ( $V_2, V_4$ )        | $MV$        | $V_L - 0.3$ to $V_M + 0.3$ | V  |
| • Output voltage ( $V_1, V_3$ )        | $HV$        | $V_L - 0.3$ to $V_H + 0.3$ | V  |
| • Output voltage ( $V_{SHT}$ )         | $HHV$       | $V_L - 0.3$ to $V_H + 0.3$ | V  |
| • Operational amplifier output current | $I_{DCOUT}$ | $\pm 5$                    | mA |
| • Operating temperature                | $T_{opr}$   | -25 to +85                 |    |
| • Storage temperature                  | $T_{stg}$   | -40 to +125                |    |

### Recommended Operating Conditions

|                                       |           |              |   |
|---------------------------------------|-----------|--------------|---|
| • Supply voltage                      | $V_H$     | 11.5 to 15.5 | V |
| • Supply voltage                      | $V_M$     | 0            | V |
| • Supply voltage                      | $V_L$     | -4.5 to -9.0 | V |
| • Input voltage (except for pin 3)    | $V_I$     | 0 to 6.0     | V |
| • Operational amplifier input voltage | $V_{IOP}$ | 1.0 to 4.5   | V |
| • Operating temperature               | $T_{opr}$ | -20 to +75   |   |

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## Block Diagram and Pin Configuration (Top View)



## Pin Description

| Pin No. | Symbol         | I/O | Description   |
|---------|----------------|-----|---|
| 1       | CPP3           | O   | Charge pump   |
| 2       | V <sub>H</sub> | -   | Power supply (15V)  |
| 3       | DCIN           | I   | Operational amplifier input   |
| 4       | XSHT           | I   | Output control (VSHT)   |
| 5       | XV2            | I   | Output control (V <sub>2</sub> )  |
| 6       | XV1            | I   | Output control (V <sub>1</sub> )  |
| 7       | XSG1           | I   | Output control (V <sub>1</sub> )  |
| 8       | XV3            | I   | Output control (V <sub>3</sub> )  |
| 9       | XSG2           | I   | Output control (V <sub>3</sub> )  |
| 10      | XV4            | I   | Output control (V <sub>4</sub> )  |
| 11      | V <sub>4</sub> | O   | High-voltage output (2 levels: V <sub>M</sub> , V <sub>L</sub> )                  |
| 12      | V <sub>3</sub> | O   | High-voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> ) |
| 13      | V <sub>M</sub> | -   | GND   |
| 14      | V <sub>1</sub> | O   | High-voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> ) |
| 15      | V <sub>2</sub> | O   | High-voltage output (2 levels: V <sub>M</sub> , V <sub>L</sub> )                  |
| 16      | V <sub>L</sub> | -   | Power supply (-8.5V)  |
| 17      | VSHT           | O   | High-voltage output (2 levels: V <sub>H</sub> , V <sub>L</sub> )                  |
| 18      | DCOUT          | O   | Operational amplifier output  |
| 19      | CPP2           | -   | Charge pump   |
| 20      | CPP1           | -   | Charge pump   |

Truth Table

| Input  |         |        |      | Output         |                |                |
|--------|---------|--------|------|----------------|----------------|----------------|
| XV1, 3 | XSG1, 2 | XV2, 4 | XSHT | V 1, 3         | V 2, 4         | VSHT           |
| L      | L       | X      | X    | V <sub>H</sub> | X              | X              |
| H      | L       | X      | X    | Z              | X              | X              |
| L      | H       | X      | X    | V <sub>M</sub> | X              | X              |
| H      | H       | X      | X    | V <sub>L</sub> | X              | X              |
| X      | X       | L      | X    | X              | V <sub>M</sub> | X              |
| X      | X       | H      | X    | X              | V <sub>L</sub> | X              |
| X      | X       | X      | L    | X              | X              | V <sub>H</sub> |
| X      | X       | X      | H    | X              | X              | V <sub>L</sub> |

X: Don't care

Z: High impedance

## Electrical Characteristics

## DC Characteristics

(Unless otherwise specified, Ta = 25 °C, V<sub>H</sub> = 15V, V<sub>M</sub> = GND, V<sub>L</sub> = -8.5V)

| Item                        | Symbol            | Condition  | Min. | Typ.  | Max. | Unit |
|-----------------------------|-------------------|--|------|-------|------|------|
| High level input voltage    | V <sub>IH</sub>   |  | 2.3  | -     | -    | V    |
| Low level input voltage     | V <sub>IL</sub>   |  | -    | -     | 1.3  | V    |
| High level output voltage   | V <sub>OH</sub>   | I <sub>O</sub> = -20μA   | 14.9 | 15.0  | -    | V    |
| Middle level output voltage | V <sub>OM1</sub>  | I <sub>O</sub> = 20μA  | -    | 0.0   | 0.1  | V    |
| Middle level output voltage | V <sub>OM2</sub>  | I <sub>O</sub> = -20μA   | -0.1 | 0.0   | -    | V    |
| Low level output voltage    | V <sub>OL</sub>   | I <sub>O</sub> = 20μA  | -    | -8.5  | -8.4 | V    |
| Charge pump output voltage  | V <sub>CPP3</sub> | -1 I <sub>CPP3</sub> 0mA<br>I <sub>DCOUT</sub> = 0mA, Ta = -20 to 75 °C<br>V <sub>IOP</sub> = 4.5V | 20   | -     | -    | V    |
| Input current               | I <sub>I</sub>    | V <sub>I</sub> = V <sub>L</sub> to 5V  | -1.0 | 0.0   | 1.0  | μA   |
| Operating supply current    | I <sub>H</sub>    | *1   | -    | 1.4   | 2.0  | mA   |
| Operating supply current    | I <sub>L</sub>    | *1   | -6.0 | -5.0  | -    | mA   |
| Output current              | I <sub>OL</sub>   | V 1 to 4 = -8.0V   | 25   | -     | -    | mA   |
| Output current              | I <sub>OM1</sub>  | V 1 to 4 = -0.5V   | -    | -     | -10  | mA   |
| Output current              | I <sub>OM2</sub>  | V 1, 3 = 0.5V  | 9    | -     | -    | mA   |
| Output current              | I <sub>OH</sub>   | V 1, 3 = 14.5V   | -    | -     | -12  | mA   |
| Output current              | I <sub>OSL</sub>  | VSHT = -8.0V   | 12   | -     | -    | mA   |
| Output current              | I <sub>OSH</sub>  | VSHT = 14.5V   | -    | -     | -7   | mA   |
| Operational amplifier gain  | G                 | I <sub>DCOUT</sub> = -200/+100μA   | -    | x4.40 | -    |      |
| Gain error                  | G                 | Ta = -20 to 75 °C *2<br>I <sub>DCOUT</sub> = -200/+100μA<br>V <sub>IOP</sub> = 1.0 to 4.5V         | -3   | -     | +3   | %    |

\*1 See Measurement Circuit. Shutter speed: 1/10000.

\*2 See Operational Amplifier Gain Characteristic.

**Note)** Current directions: + indicates the direction flowing to IC; - indicates the direction flowing from IC

**Switching Characteristics**(V<sub>I</sub> = 5V, V<sub>H</sub> = 15V, V<sub>M</sub> = GND, V<sub>L</sub> = -8.5V)

| Item                      | Symbol           | Conditions                       | Min. | Typ. | Max. | Unit |
|---------------------------|------------------|----------------------------------|------|------|------|------|
| Propagation delay time    | T <sub>PLM</sub> | *1                               | 30   | 50   | 75   | ns   |
| Propagation delay time    | T <sub>PMH</sub> | *1                               | 30   | 50   | 75   | ns   |
| Propagation delay time    | T <sub>PLH</sub> | *1                               | 30   | 50   | 75   | ns   |
| Propagation delay time    | T <sub>PML</sub> | *1                               | 50   | 80   | 120  | ns   |
| Propagation delay time    | T <sub>PHM</sub> | *1                               | 50   | 80   | 120  | ns   |
| Propagation delay time    | T <sub>PHL</sub> | *1                               | 50   | 80   | 120  | ns   |
| Rise time                 | T <sub>TLM</sub> | V <sub>L</sub> V <sub>M</sub> *1 | 360  | 600  | 900  | ns   |
| Rise time                 | T <sub>TMH</sub> | V <sub>M</sub> V <sub>H</sub> *1 | 330  | 550  | 770  | ns   |
| Rise time                 | T <sub>TLH</sub> | V <sub>L</sub> V <sub>H</sub> *1 | 30   | 50   | 75   | ns   |
| Fall time                 | T <sub>TML</sub> | V <sub>M</sub> V <sub>L</sub> *1 | 180  | 300  | 500  | ns   |
| Fall time                 | T <sub>THM</sub> | V <sub>H</sub> V <sub>M</sub> *1 | 330  | 550  | 770  | ns   |
| Fall time                 | T <sub>THL</sub> | V <sub>H</sub> V <sub>L</sub> *1 | 24   | 40   | 60   | ns   |
| Charge pump boosting time | T <sub>C</sub>   | *2                               | -    | -    | 10   | ms   |
| Output noise voltage      | V <sub>CLH</sub> | *3                               | -    | -    | 0.5  | V    |
| Output noise voltage      | V <sub>CLL</sub> | *3                               | -    | -    | 0.5  | V    |
| Output noise voltage      | V <sub>CMH</sub> | *3                               | -    | -    | 0.5  | V    |
| Output noise voltage      | V <sub>CML</sub> | *3                               | -    | -    | 0.5  | V    |

\*1 See Response of Voltage Pulse. Maximum and minimum values depend on variation of process and temperature, etc. at the mentioned drive voltage.

\*2 CP1 = 0.1μF, CP2 = 0.1μF, V<sub>CPP3</sub> = 20V; boosting time after all power supplies rose.

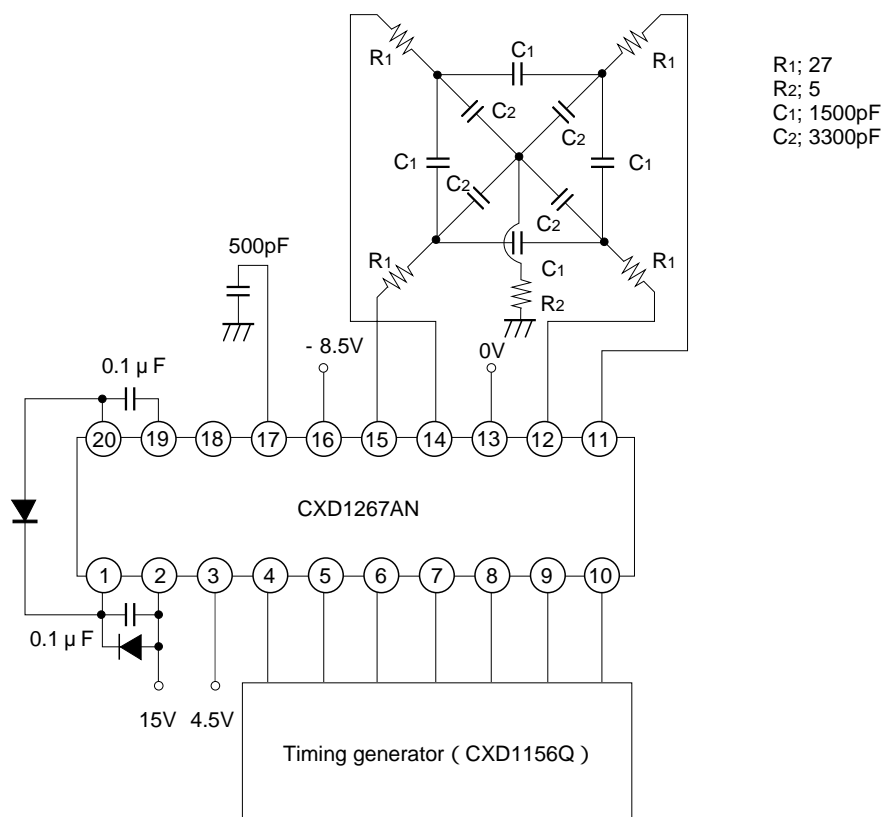
\*3 See Noise on a Waveform.

**Note)** Each item is evaluated by Measurement Circuit.

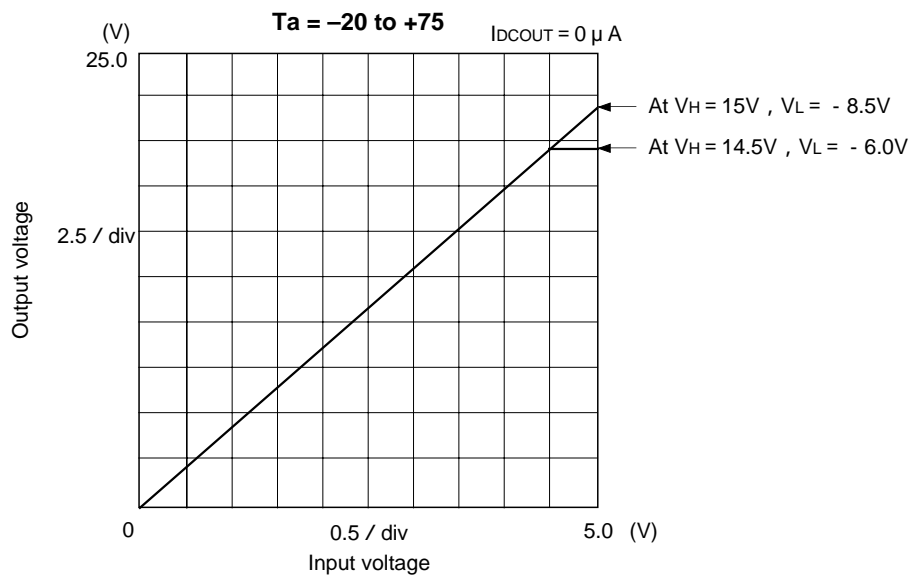
**Notes on Operation** (See Application Circuit.)

1. Be sure to protect against static electricity because this IC is MOS structure.
2. A bypass capacitor is connected between each power supply (V<sub>H</sub>, V<sub>L</sub>) and GND.
3. To prevent latch-up, use a capacitor of 0.1μF (CP1, CP2) for charge pump.  
Insert a silicon diode (D2) between CPP3 and CPP1.
4. In order to protect CCD image sensor, pre-clamp is requested prior to clamp by DCOUT.

## Measurement Circuit



## Operational Amplifier Gain Characteristics

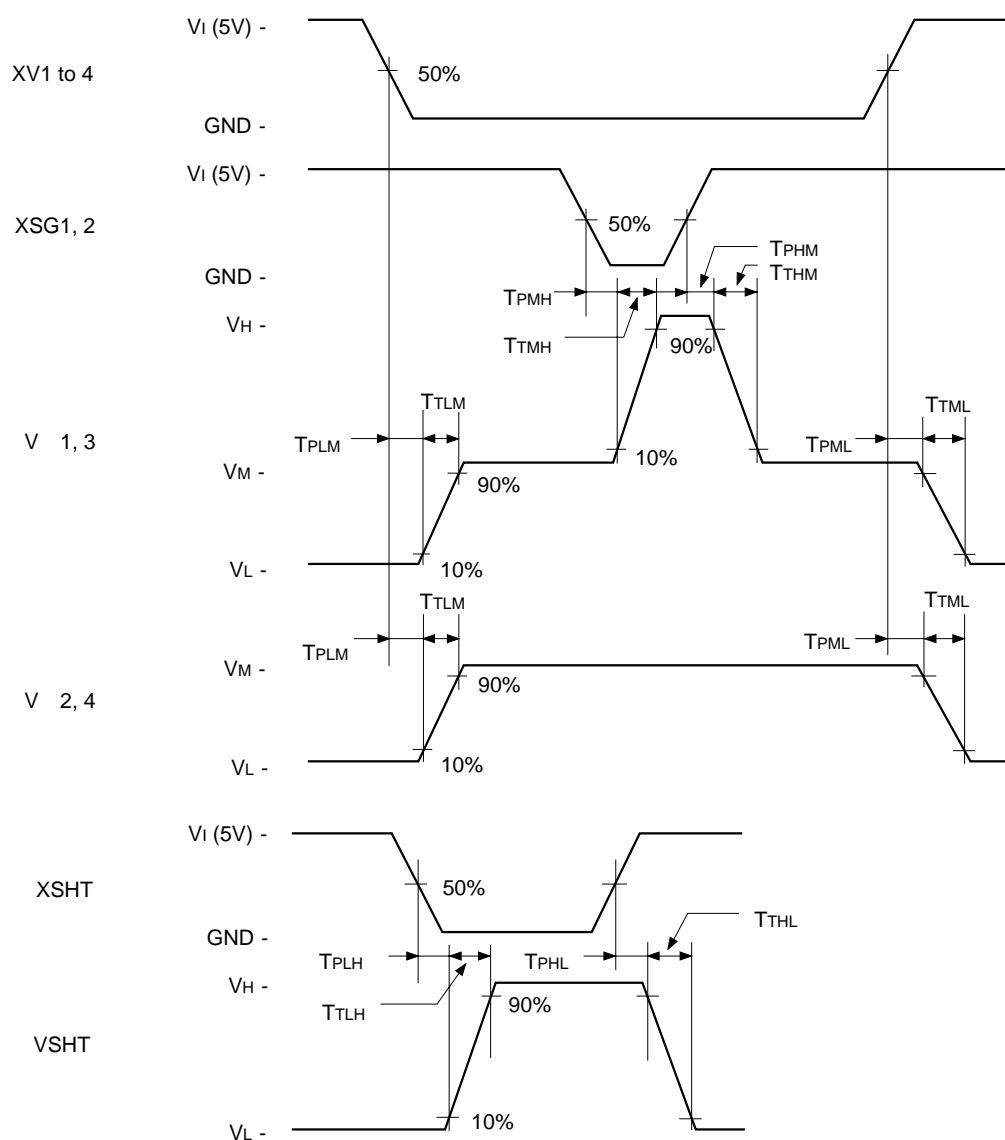


**Note)** Operating amplifier maximum output voltage is restricted as shown in the formula below depending on supply voltage setting of  $V_H$  and  $V_L$ .

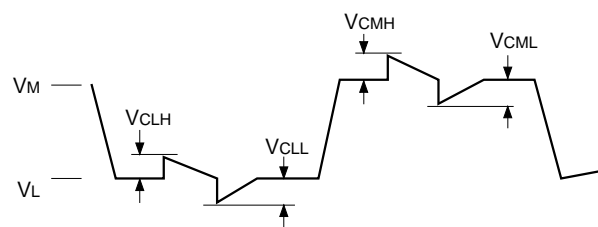
$$\text{Maximum output voltage } V_{DCOUT}(\text{max}) = V_H + |V_L| - 0.8V$$

For instance, when  $V_H = 14.5V$  and  $V_L = -6.0V$ , output voltage is saturated at approximately 19.7V as shown above figure.

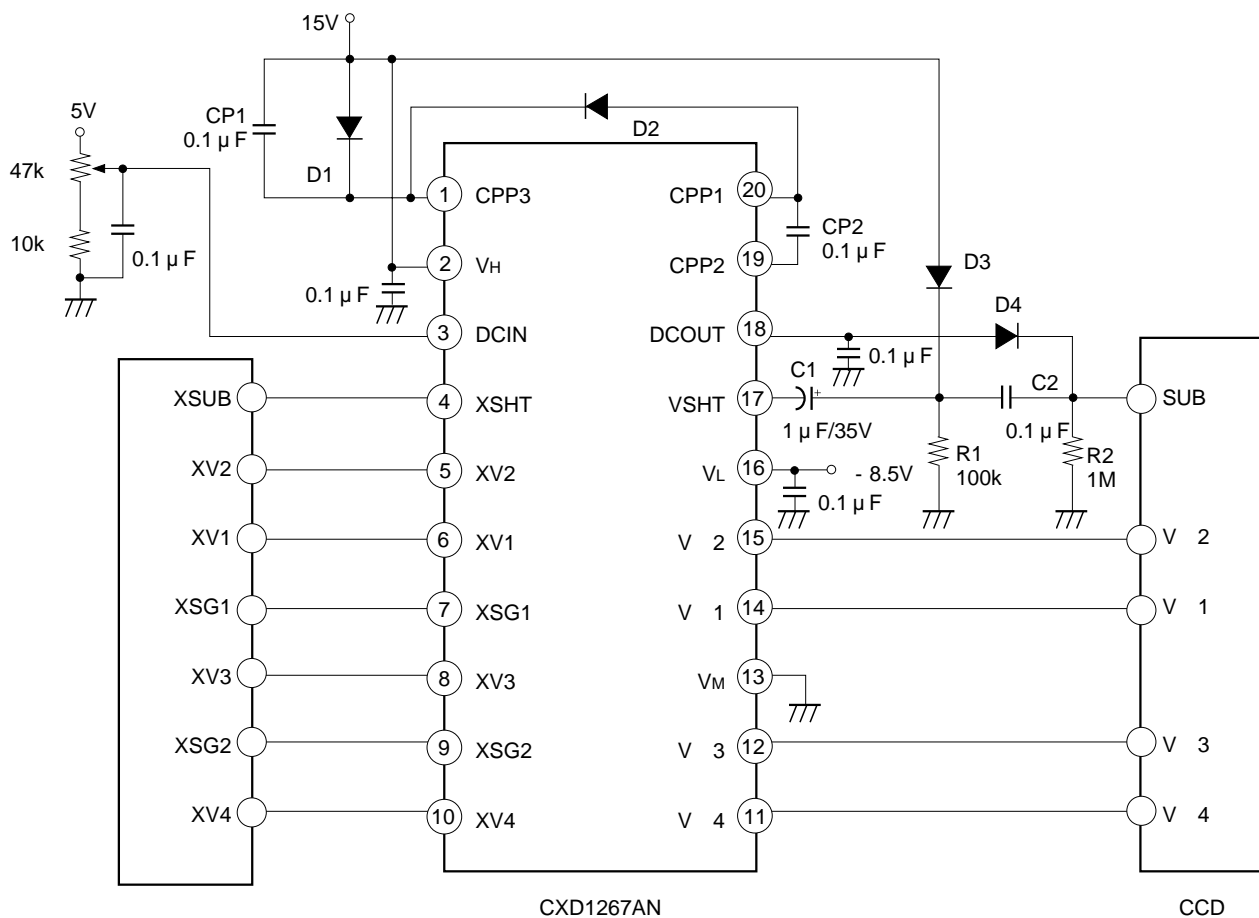
## Response of Voltage Pulse



## Noise on a Waveform



# Application Circuit

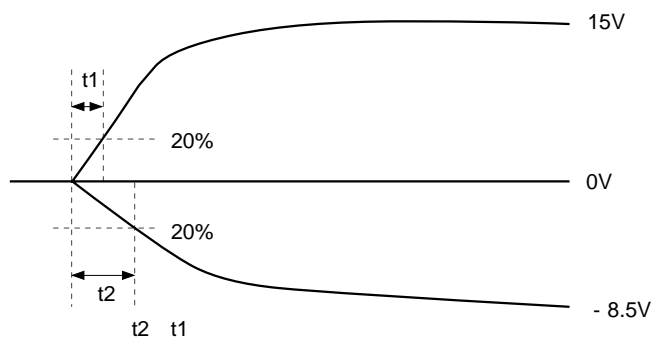


\* A peripheral circuit can be simplified by CCD image sensor.

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## Note with power-on sequence

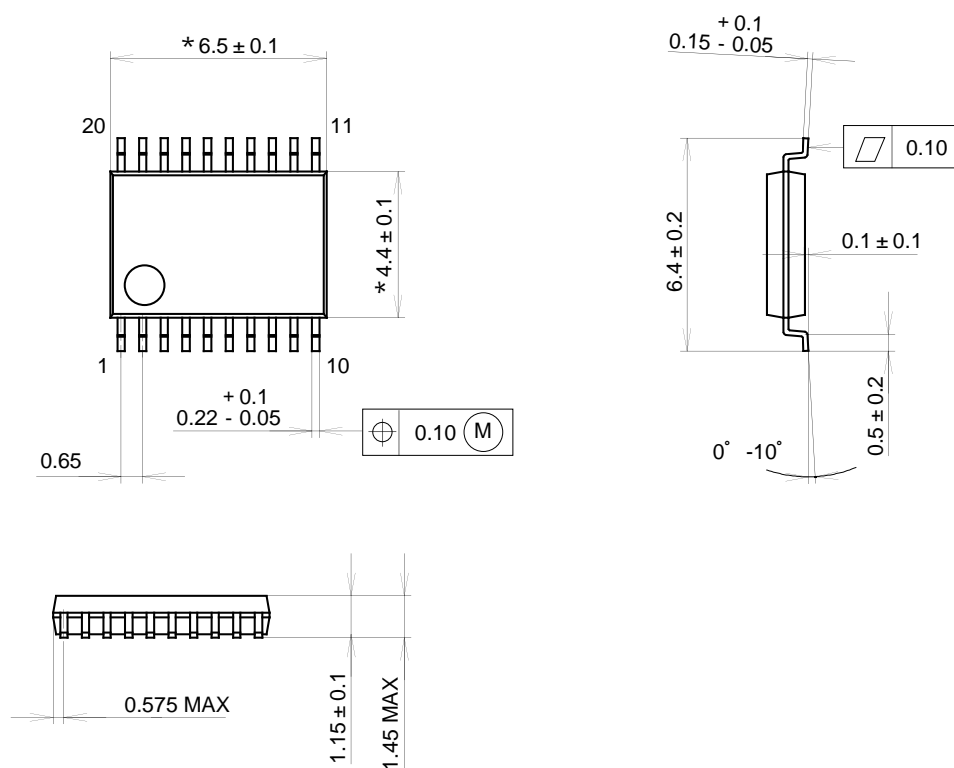
To protect CCD image sensor, rise two power supplies as follows.



## Package Outline

Unit : mm

## 20PIN SSOP (Plastic)



NOTE > Dimension “ \* ” does not include mold protrusion.

## PACKAGE STRUCTURE

|            |                   |
|------------|-------------------|
| SONY CODE  | SSOP-20P-L071     |
| EIAJ CODE  | SSOP020-P-0044-AN |
| JEDEC CODE | _____             |

|                  |                |
|------------------|----------------|
| PACKAGE MATERIAL | EPOXY RESIN    |
| LEAD TREATMENT   | SOLDER PLATING |
| LEAD MATERIAL    | Cu ALLOY       |
| PACKAGE WEIGHT   | 0.1g           |



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